

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicants:** Colgan, et al.

**Examiner:** Mitchell, James M.

**Serial No.:** 10/789,500

**Group:** Art Unit 2813

**Filed:** February 27, 2004

**Docket:** YOR920030527US1 (8728-665)

**For:        APPARATUS AND METHODS FOR COOLING**

**SEMICONDUCTOR INTEGRATED CIRCUIT PACKAGE STRUCTURES**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

**AMENDMENT**

This is a response to the Office Communication of October 17, 2006, and is being submitted to supplement to the Amendment filed on July 25, 2006. Please amend the application as follows.